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Kind regards,

Team Nexperia

Product data sheet

## 1. General description

Dual Planar Schottky barrier diode in common anode configuration with an integrated guard ring for stress protection, encapsulated in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

## 3. Applications

- Ultra high-speed switching
- Line termination
- Voltage clamping
- Reverse polarity protection

## 4. Quick reference data

Table 1. Quid	ck reference data						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per diode							,
I <sub>F</sub>	forward current			-	-	200	mA
V <sub>R</sub>	reverse voltage			-	-	30	V
Per diode							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 mA; T <sub>amb</sub> = 25 °C		-	-	400	mV





**Dual Schottky barrier diode** 

## 5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	3	A1, A2
2	K2	cathode (diode 2)		
3	A1, A2	common anode	1 ☐ ☐ 2 SC-70 (SOT323)	aaa-004974

## 6. Ordering information

Table 3. Ordering in	formation		
Type number	Package		
	Name	Description	Version
1PS70SB16	SC-70	plastic surface-mounted package; 3 leads	SOT323

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
	[1]
1PS70SB16	7%6

[1] % = placeholder for manufacturing site code

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V <sub>R</sub>	reverse voltage		-	30	V
I <sub>F</sub>	forward current		-	200	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1 \text{ s}; \delta \le 0.5$	-	300	mA
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ < 10 ms; $T_{j(init)}$ = 25 °C	-	600	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> < 25 °C	-	200	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	150	°C

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#### **Dual Schottky barrier diode**

Symbol	Parameter	Conditions	Min	Max	Unit
T <sub>stg</sub>	storage temperature		-65	150	°C

## 9. Thermal characteristics

Table 6. The	rmal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per device							
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	-	625	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

# **10. Characteristics**

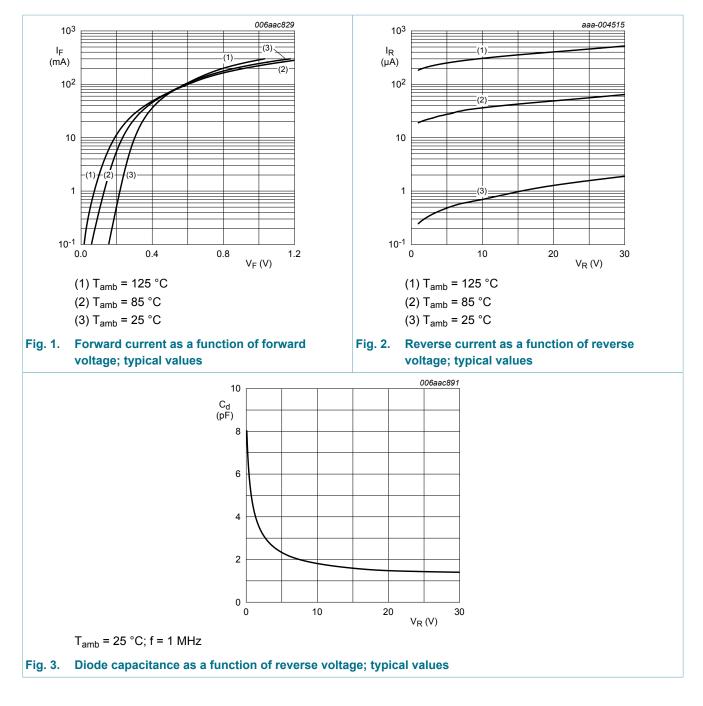
Table 7. C	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode		· · · · · · · · · · · · · · · · · · ·				
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 mA; T <sub>amb</sub> = 25 °C	-	-	240	mV
	I <sub>F</sub> = 1 mA; T <sub>amb</sub> = 25 °C	-	-	320	mV	
	I <sub>F</sub> = 10 mA; T <sub>amb</sub> = 25 °C	-	-	400	mV	
		I <sub>F</sub> = 30 mA; T <sub>amb</sub> = 25 °C	-	-	500	mV
		I <sub>F</sub> = 100 mA; T <sub>amb</sub> = 25 °C	-	-	800	mV
I <sub>R</sub>	reverse current	$V_R$ = 25 V; pulsed; t <sub>p</sub> = 300 μs; δ = 0.02 ; T <sub>amb</sub> = 25 °C	-	-	2	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	-	10	pF

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#### **Dual Schottky barrier diode**



## **11. Test information**

#### **11.1 Quality information**

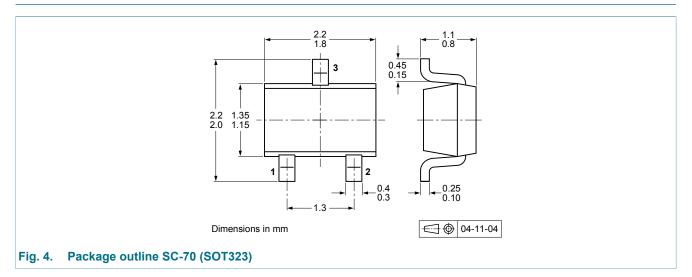
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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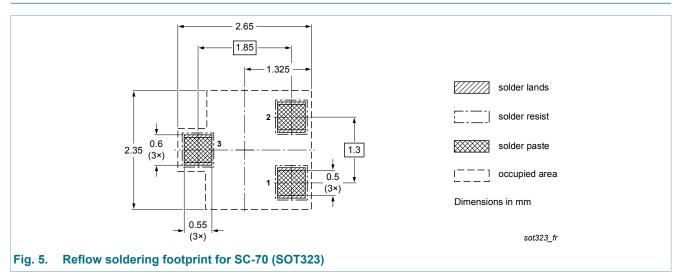
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**Dual Schottky barrier diode** 

## 12. Package outline



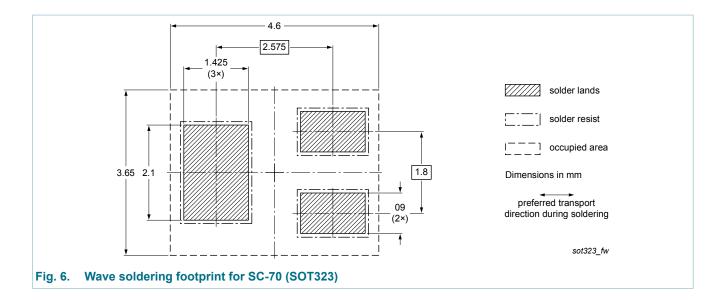
## 13. Soldering



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#### **Dual Schottky barrier diode**



# 14. Revision history

Table 8. Revision his	story			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
1PS70SB16 v.2	20121217	Product data sheet	-	1PS70SB10_14_15_16 v.1
Modifications:	of NXP Semiconduc Legal texts have be Sections 1 to 3 upda Section 4 "Quick ref Section 6 "Ordering Section 7 "Marking" Table 5 "Limiting va Figues 1, 2 and 3 up Section 11 "Test info	ctors. en adapted to the new co ated ference data" added information" added updated lues": ambient temperatu odated ormation" added ed by minimized package ng" added	igned to comply with the ompany name where app and junction tem outline drawing	ropriate.
1PS70SB10_14_15_16 v.1	19990426	Product data sheet	-	-

#### **Dual Schottky barrier diode**

## 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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